

### **Features**

- Planar Structure Die and Soft Recovery Characteristics
- Super Fast Reverse Recovery Time
- Lead Free Finish/RoHS Compliant (Note 1)("P" Suffix Designates RoHS Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free. "Green" Device (Note 2)
- Moisture Sensitivity Level 1

# 3 Amp Surface Mount FRED Rectifiers 600 Volts

### Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	$V_{RRM}$		V	
Working Peak Reverse Voltage	V <sub>RWM</sub>	600		
DC Blocking Voltage	V <sub>R</sub>			
RMS Reverse Voltage	V <sub>RMS</sub>	420	V	
Average Rectified Forward Current @ T <sub>L</sub> =100°C	I <sub>F(AV)</sub>	3	А	
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave		60	А	
Non-Repetitive Peak Surge Current @1ms Square Wave	I <sub>FSM</sub>	120	A	
Current Squared Time @ 1ms≤t≤8.3ms	l <sup>2</sup> t	14.9	A <sup>2</sup> s	

# F 0.065 0 G 0.200 0 H 0.160 0

### **Internal Structure**

Pin	Description	Simplified Outline	Graphic Symbol
1	Cathode	, MCC	
2	Anode	1 MCC MURF3JB 2	1 00 2

### Note:

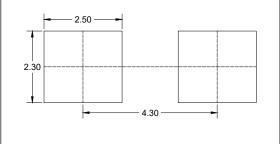
- 1. High temperature solder exemption applied, see EU directive annex 7a.
- 2. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

# SMB (DO-214AA)

DIMENSIONS						
DIM INCHES		HES	M	NOTE		
Dilvi	MIN MAX		MIN	MAX	NOTE	
Α	0.079	0.103	2.00	2.62		
В	0.075	0.087	1.91	2.21		
С	0.002	0.008	0.05	0.20		
D	0.006	0.012	0.15	0.31		
Е	0.030	0.060	0.76	1.52		
F	0.065	0.091	1.65	2.32		
G	0.200	0.220	5.08	5.59		
Н	0.160	0.191	4.06	4.85		
J	0.130	0.155	3.30	3.94		

### Suggested Solder Pad Layout

Unit:mm





### Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_J$	Operating Junction Temperature Range		-55		175	°C
T <sub>stg</sub>	Storage Temperature Range		-55		175	°C
Rth <sub>(J-L)</sub>	Thermal Resistance from Junction to Lead	Note 1		20		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 1		70		°C/W

### Note:

# Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =3A;T <sub>J</sub> =25°C			1.30	V
Reverse Current	I <sub>R</sub>	at Rated $V_R;T_J=25^{\circ}C$ at Rated $V_R;T_J=125^{\circ}C$			5 100	μA
Junction Capacitance	CJ	V <sub>R</sub> =4V;f=1MHz;T <sub>J</sub> =25°C		26		pF

# Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
		I <sub>F</sub> =0.5A; I <sub>R</sub> =1.0A; I <sub>RR</sub> =0.25A; T <sub>J</sub> =25°C				50	
		I <sub>F</sub> =1A; di/dt=-50A/μs; V <sub>R</sub> =30V; T <sub>J</sub> =25°C			45		
Reverse Recovery Time	t <sub>rr</sub>		T <sub>J</sub> =25°C		49		ns
			T <sub>J</sub> =125°C		61		
Dook Doosyamy Cumant		I <sub>F</sub> =3A di/dt=-200A/µs	T <sub>J</sub> =25°C		2.6		Α
Peak Recovery Current	I <sub>RRM</sub>	V <sub>R</sub> =400 V	T <sub>J</sub> =125°C		4.6		A
Doverse Decement Charge			T <sub>J</sub> =25°C		63		nC
Reverse Recovery Charge	Q <sub>rr</sub>		T <sub>J</sub> =125°C		138		ПС

<sup>1.</sup>Mounted on P.C.B. with 8mm\*8mm copper pad areas.



### **Curve Characteristics**

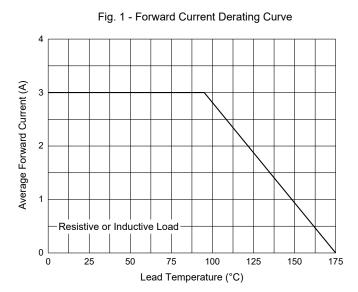


Fig. 3 - Typical Instantaneous Forward Characteristics

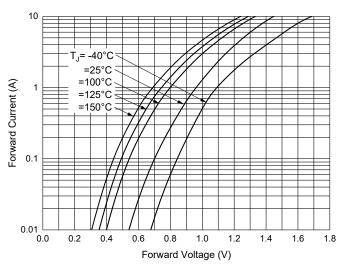


Fig. 5 - Typical Capacitance Characteristics

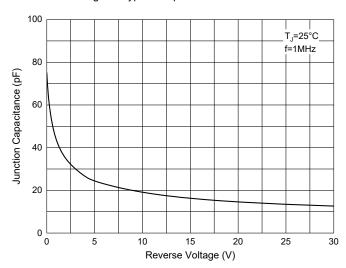


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge
Current

75

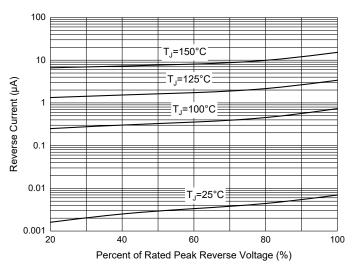
45

8.3 ms Single Half Sine-Wave

1 10 100

Fig. 4 - Typical Reverse Leakage Characteristics

Number of Cycles at 60 Hz





### **Ordering Information**

Device	Packing
MURF3JB-TP	Tape&Reel:3Kpcs/Reel

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